



AO3460

60V N-Channel MOSFET

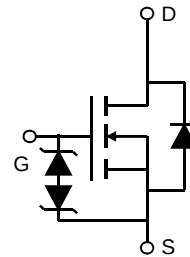
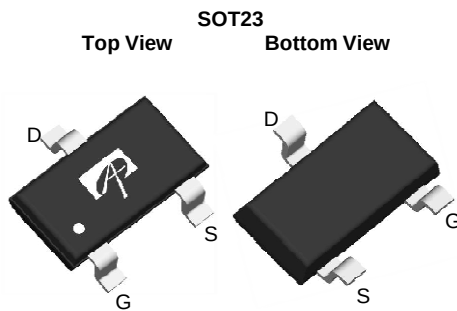
General Description

The AO3460 uses advanced trench technology to provide excellent $R_{DS(ON)}$, low gate charge, and operation with gate voltages as low as 4.5V, in the small SOT-23 footprint. It can be used for a wide variety of applications, including load switching, low current inverters and low current DC-DC converters. It is ESD protected.

Product Summary

V_{DS} (V) = 60V
 I_D = 0.65A (V_{GS} = 10V)
 $R_{DS(ON)} < 1.7\Omega$ (V_{GS} = 10V)
 $R_{DS(ON)} < 2\Omega$ (V_{GS} = 4.5V)

ESD protected



Absolute Maximum Ratings $T_A=25^\circ\text{C}$ unless otherwise noted

Parameter	Symbol	Maximum	Units
Drain-Source Voltage	V_{DS}	60	V
Gate-Source Voltage	V_{GS}	± 20	V
Continuous Drain Current ^{A, F}	I_D	0.65	A
$T_A=25^\circ\text{C}$			
$T_A=70^\circ\text{C}$		0.5	
Pulsed Drain Current ^B	I_{DM}	1.6	
Power Dissipation ^A	P_D	1.4	W
$T_A=25^\circ\text{C}$			
$T_A=70^\circ\text{C}$		0.9	
Junction and Storage Temperature Range	T_J, T_{STG}	-55 to 150	$^\circ\text{C}$

Thermal Characteristics

Parameter	Symbol	Typ	Max	Units
Maximum Junction-to-Ambient ^A	$R_{\theta JA}$	70	90	$^\circ\text{C/W}$
$t \leq 10\text{s}$				
Maximum Junction-to-Ambient ^A	$R_{\theta JA}$	100	125	$^\circ\text{C/W}$
Steady-State				
Maximum Junction-to-Lead ^C	$R_{\theta JL}$	63	80	$^\circ\text{C/W}$
Steady-State				

Electrical Characteristics ($T_J=25^{\circ}\text{C}$ unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ	Max	Units
STATIC PARAMETERS						
BV_{DSS}	Drain-Source Breakdown Voltage	$I_D=250\mu\text{A}$, $V_{GS}=0\text{V}$	60			V
I_{DSS}	Zero Gate Voltage Drain Current	$V_{DS}=60\text{V}$, $V_{GS}=0\text{V}$ $T_J=55^{\circ}\text{C}$			1 5	μA
I_{GSS}	Gate-Body leakage current	$V_{DS}=0\text{V}$, $V_{GS}=\pm 20\text{V}$			± 10	μA
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS}=V_{GS}$, $I_D=250\mu\text{A}$	1	2.2	2.5	V
$I_{D(ON)}$	On state drain current	$V_{GS}=10\text{V}$, $V_{DS}=5\text{V}$	1.6			A
$R_{DS(ON)}$	Static Drain-Source On-Resistance	$V_{GS}=10\text{V}$, $I_D=0.65\text{A}$ $T_J=125^{\circ}\text{C}$		1.4 2.5	1.7 3	Ω
		$V_{GS}=4.5\text{V}$, $I_D=0.5\text{A}$		1.6	2	Ω
g_{FS}	Forward Transconductance	$V_{DS}=5\text{V}$, $I_D=0.65\text{A}$		0.8		S
V_{SD}	Diode Forward Voltage	$I_S=0.1\text{A}$, $V_{GS}=0\text{V}$		0.8	1	V
I_S	Maximum Body-Diode Continuous Current				1.2	A
DYNAMIC PARAMETERS						
C_{iss}	Input Capacitance	$V_{GS}=0\text{V}$, $V_{DS}=30\text{V}$, $f=1\text{MHz}$		22	27	pF
C_{oss}	Output Capacitance			6	10	pF
C_{rss}	Reverse Transfer Capacitance			2	6	pF
R_g	Gate resistance	$V_{GS}=0\text{V}$, $V_{DS}=0\text{V}$, $f=1\text{MHz}$		250	400	Ω
SWITCHING PARAMETERS						
$Q_g(10\text{V})$	Total Gate Charge	$V_{GS}=10\text{V}$, $V_{DS}=30\text{V}$, $I_D=0.65\text{A}$		0.8	2	nC
$Q_g(4.5\text{V})$	Total Gate Charge			0.4	1.5	nC
Q_{gs}	Gate Source Charge			0.17	1	nC
Q_{gd}	Gate Drain Charge			0.2	1	nC
$t_{D(on)}$	Turn-On DelayTime	$V_{GS}=10\text{V}$, $V_{DS}=30\text{V}$, $R_L=75\Omega$, $R_{GEN}=3\Omega$		5.3	12	ns
t_r	Turn-On Rise Time			2.8	6	ns
$t_{D(off)}$	Turn-Off DelayTime			19.7	30	ns
t_f	Turn-Off Fall Time			5.5	11	ns
t_{rr}	Body Diode Reverse Recovery Time	$I_F=0.65\text{A}$, $dI/dt=100\text{A}/\mu\text{s}$, $V_{GS}=-9\text{V}$		11.3	14	ns
Q_{rr}	Body Diode Reverse Recovery Charge	$I_F=0.65\text{A}$, $dI/dt=100\text{A}/\mu\text{s}$, $V_{GS}=-9\text{V}$		7.5		nC

A: The value of $R_{\theta JA}$ is measured with the device mounted on 1in² FR-4 board with 2oz. Copper, in a still air environment with $T_A=25^{\circ}\text{C}$. The value in any given application depends on the user's specific board design.

B: Repetitive rating, pulse width limited by junction temperature.

C: The $R_{\theta JA}$ is the sum of the thermal impedance from junction to lead $R_{\theta JL}$ and lead to ambient.

D: The static characteristics in Figures 1 to 6 are obtained using $<300\mu\text{s}$ pulses, duty cycle 0.5% max.

E: These tests are performed with the device mounted on 1 in² FR-4 board with 2oz. Copper, in a still air environment with $T_A=25^{\circ}\text{C}$. The SOA curve provides a single pulse rating.

F: The current rating is based on the $t \leq 10\text{s}$ thermal resistance rating.

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TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

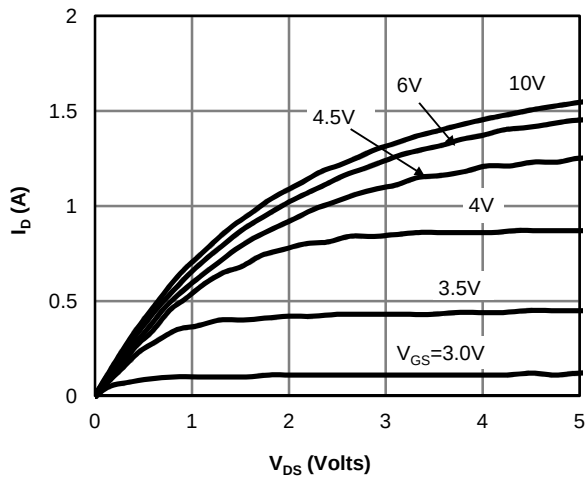


Figure 1: On-Region Characteristics

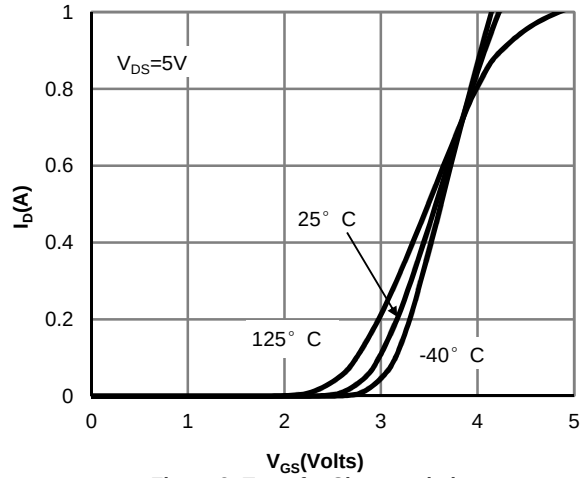


Figure 2: Transfer Characteristics

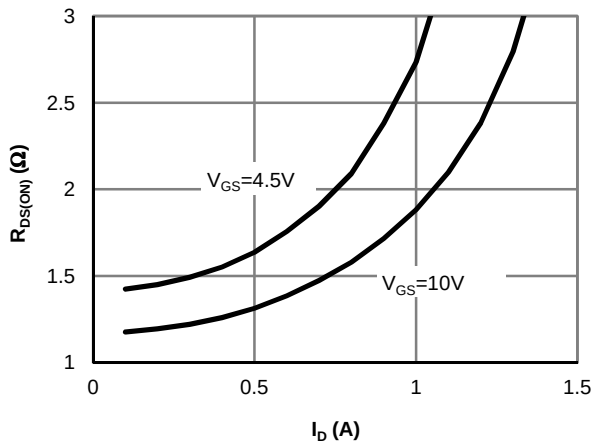


Figure 3: On-Resistance vs. Drain Current and Gate Voltage

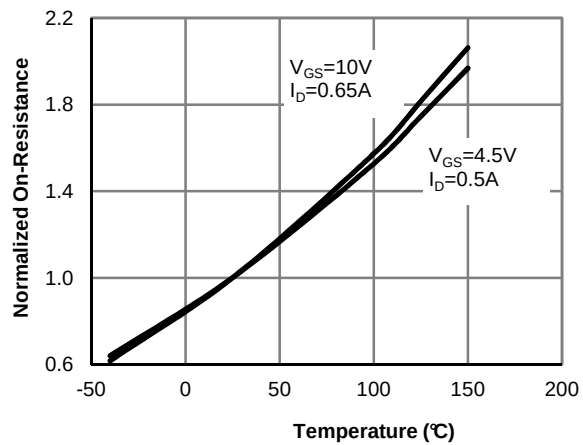


Figure 4: On-Resistance vs. Junction Temperature

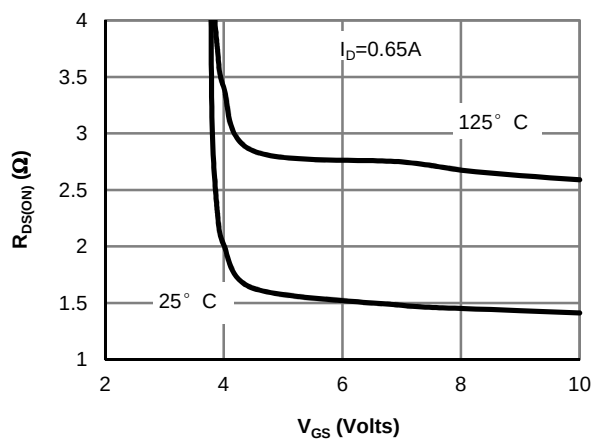


Figure 5: On-Resistance vs. Gate-Source Voltage

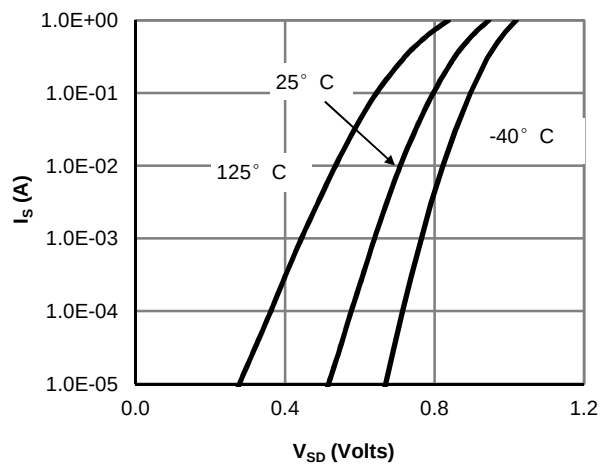


Figure 6: Body-Diode Characteristics

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